

C1206C103J3GAC7210

SMD Comm COG, Ceramic, 0.01 uF, 5%, 25 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1206



Click here for the 3D model.

Dimensions	
Chip Size	1206
L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
Т	1mm +/-0.10mm
В	0.5mm +/-0.25mm

Packaging Specifications		
Pa	ckaging	T&R, 330mm, Plastic Tape
Pa	ckaging Quantity	10000
Pa	ckaging Quantity	10000

General Information				
Series	SMD Comm COG			
Style	SMD Chip			
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I			
Features	Ultra-Stable, Low Loss, Class I			
RoHS	Yes			
Termination	Tin			
Marking	No			
AEC-Q200	No			
Component Weight	25 mg			
Shelf Life	78 Weeks			
MSL	1			

Specifications			
Capacitance	0.01 uF		
Measurement Condition	1 kHz 1.0Vrms		
Capacitance Tolerance	5%		
Voltage DC	25 VDC		
Dielectric Withstanding Voltage	62.5 VDC		
Temperature Range	-55/+125°C		
Temperature Coefficient	COG		
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms		
Dissipation Factor	0.1% 1 kHz 1.0Vrms		
Aging Rate	0% Loss/Decade Hour		
Insulation Resistance	100 GOhms		

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